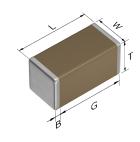
## 积层贴片陶瓷片式电容器

## C3216X7S0J226M160AB

RoHS Reach Halogen Free Pb Free

交货型号	C3216X7S0J226MT****
用途	一般等级
特点	General 一般(~75V)
系列	C3216 [EIA 1206]
状态	量产体制



尺寸		
长度(L)	$3.20 \text{mm} \pm 0.20 \text{mm}$	
宽度(W)	1.60mm ±0.20mm	
厚度(T)	1.60mm ±0.20mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	1.00mm Min.	
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)	
1世代·拜益·仰/四 (L f.)	2.00mm to 2.40mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)	
1世存/杆益和/四 (FD)	1.00mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)	
3世代丹並仰四日日	1.10mm to 1.60mm(Reflow Soldering)	

· · · · · · · · · · · · · · · · · · ·	气特性
电容	22 μ F ±20%
额定电压	6. 3VDC
温度特性	$X7S (\pm 22\%)$
耗散因数(Max.)	10%
绝缘电阻 (Min.)	4ΜΩ

	其他	
kH +∞ → >+	流体	
焊接方法	回流	
AEC-Q200	NO	
包裝形式	塑封编带(180mm卷筒)	
包装个数	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

 $<sup>! \ \</sup>mbox{All specifications}$  are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

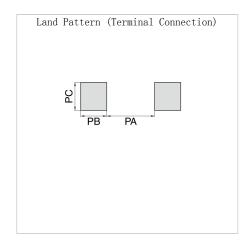
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## Associated Images



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